TOSHIBA Field-Effect Transistor Silicon N-Channel MOS Type

SSM6K208FE

- High-Speed Switching Applications
- O Power Management Switch Applications

• 1.8V drive

• Low ON-resistance: $R_{on} = 296 \text{ m}\Omega \text{ (max) (@V_{GS} = 1.8 V)}$

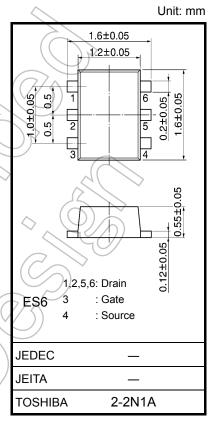
 R_{on} = 177 m Ω (max) (@V_{GS} = 2.5 V)

 $R_{on} = 133 \text{ m}\Omega \text{ (max) } (@V_{GS} = 4.0 \text{ V})$

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit	
Drain-Source voltage		V_{DSS}	30	(
Gate-Source voltage		V_{GSS}	± 12	V	
Drain current	DC	ID	1.9	A	
	Pulse	I _{DP}	3.8		
Drain power dissipation		P _D (Note 1)	500	mW	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55 to 150	√°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.



Weight: 3mg (typ.)

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on FR4 board.

 $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 1.6 \text{mm}, \text{ Cu Pad: } 645 \text{ mm}^2)$

Electrical Characteristics (Ta = 25°C)

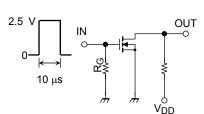
Chara	acteristic	Symbol	Test Conditions	Min	Тур.	Max	Unit
Drain-Source breakdown voltage		V (BR) DSS	I _D = 1 mA, V _{GS} = 0 V		_	_	V
		V (BR) DSX	$I_D = 1 \text{ mA}, V_{GS} = -12 \text{ V}$	18	_	_	v
Drain cut-off curre	nt	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V		_	1	μΑ
Gate leakage curr	ent	I _{GSS}	$V_{GS} = \pm 12 \text{ V}, V_{DS} = 0 \text{ V}$		_	±1	μΑ
Gate threshold vo	Itage	V _{th}	$V_{DS} = 3 \text{ V}, I_D = 1 \text{ mA}$	0.4	\\-\-\	1.0	V
Forward transfer a	admittance	Y _{fs}	$V_{DS} = 3 \text{ V}, I_D = 1.0 \text{ A}$ (Note 2)	2	3.9	_	S
		I _D = 1.0 A, V _{GS} = 4 V (Note 2)	7 (1)	103	133	mΩ	
Drain-source ON-resistance		R _{DS} (ON)	I _D = 0.8 A, V _{GS} = 2.5 V (Note 2)		125		177
			I _D = 0.5 A, V _{GS} = 1.8 V (Note 2)	> —	165		296
Input capacitance		C _{iss}		_	123	_	pF
Output capacitance		C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	43		
Reverse transfer capacitance		C _{rss}		- 0	18	>	
Total Gate Charge		Qg	(7/5)	-(1.9	> _	
Gate-Source Charge		Q _{gs}	V _{DS} = 15V, I _D = 1.9 A, V _{GS} = 4 V	7	(1,1)) —	nC
Gate-Drain Charge		Q _{gd}		2	0.8	_	
Switching time	Turn-on time	t _{on}	$V_{DD} = 15 \text{ V}, I_D = 1.0 \text{ A},$		9.2	_	
	Turn-off time	t _{off}	$V_{GS} = 0$ to 2.5 V, $R_G = 4.7 \Omega$		6.4	— ns	ns
Drain-Source forward voltage V _{DS}		V _{DSF}	$I_D = -1.9 \text{ A}, V_{GS} = 0 \text{ V}$ (Note 2)) —	-0.83	-1.2	V



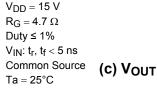


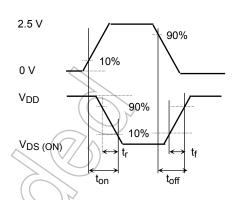
Switching Time Test Circuit

(a) Test Circuit

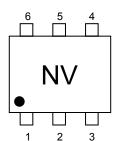


(b) V_{IN}

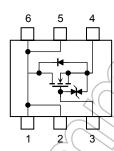




Marking



Equivalent Circuit (top view)



Usage Considerations

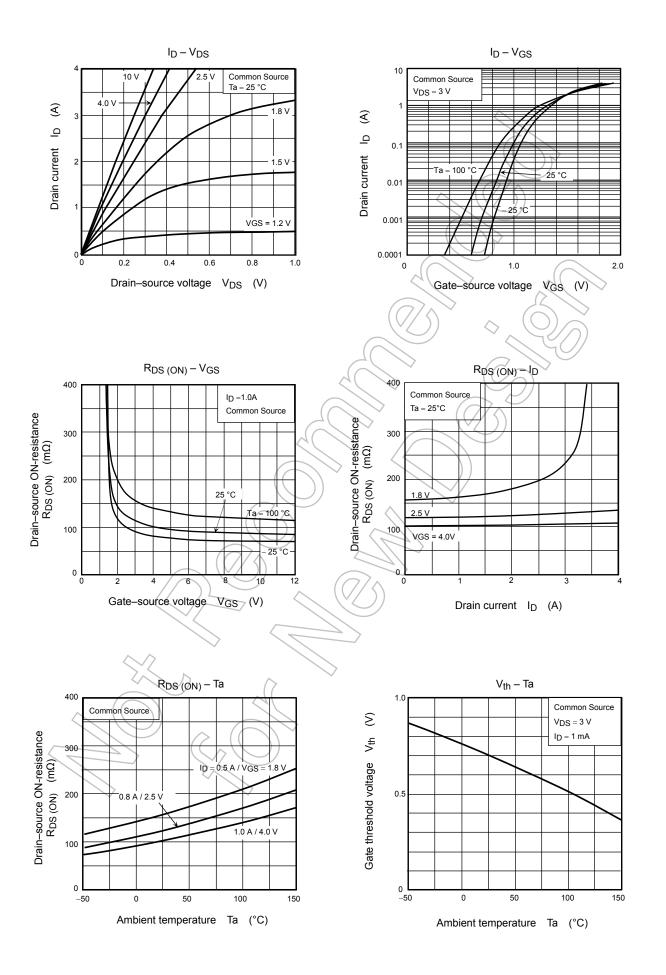
Let Vth be the voltage applied between gate and source that causes the drain current (ID) to below (1 mA for the SSM6K208FE). Then, for normal switching operation, VGS(on) must be higher than Vth, and VGS(off) must be lower than V_{th.} This relationship can be expressed as: V_{GS(off)} < V_{th} < V_{GS(on)}

Take this into consideration when using the device.

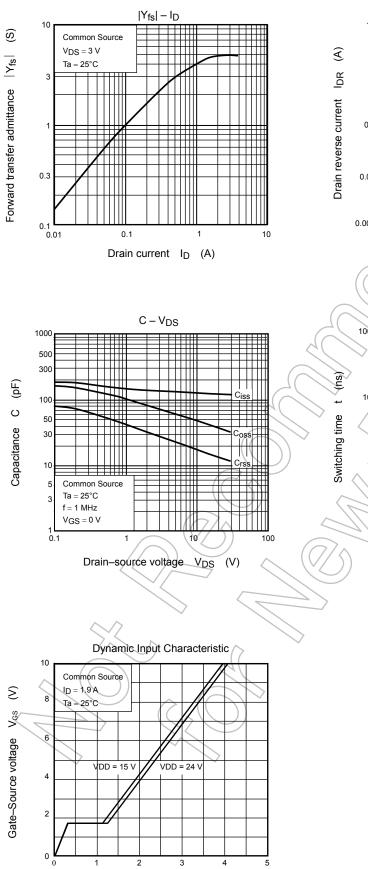
Handling Precaution

When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

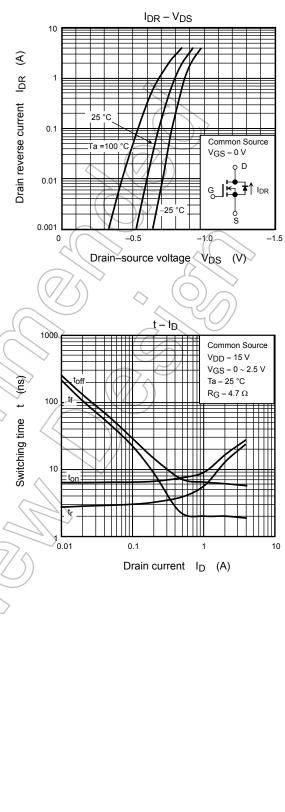




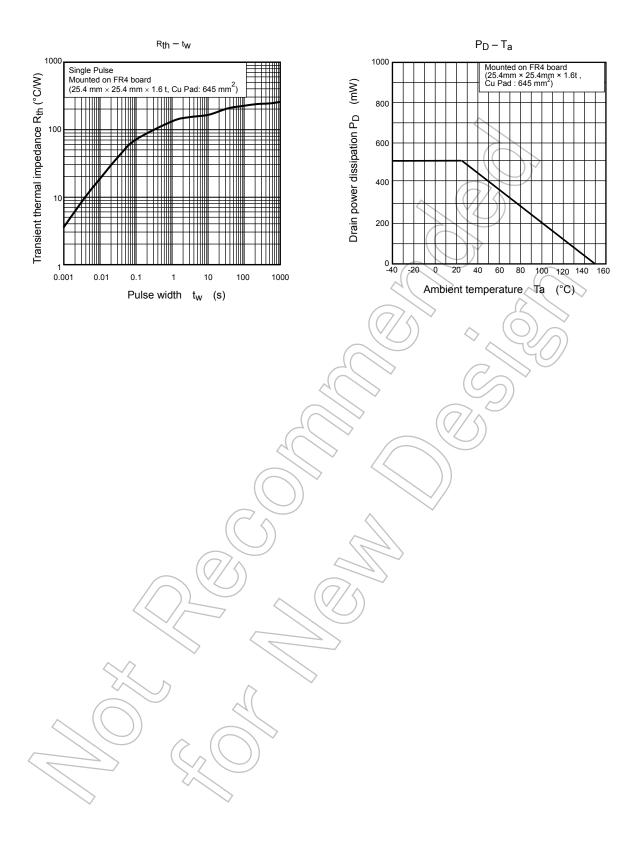
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Total Gate Charge Qg (nC)



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